

STPS1045B-Y

Automotive power Schottky rectifier

Features

- Negligible switching losses
- Low forward voltage drop
- Low capacitance
- High reverse avalanche surge capability
- Avalanche specification
- AEC-Q101 qualified

Description

High voltage Schottky rectifier suited for switch mode power supplies and other power converters.

Packaged in DPAK, this device is intended for use in high frequency circuits where low switching losses are required.

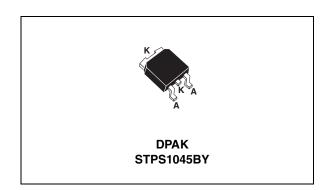


Table 1. Device summary

I _{F(AV)}	10 A
V_{RRM}	45 V
T _j	175 °C
V _F (max)	0.57 V

Characteristics STPS1045B-Y

1 Characteristics

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	Repetitive peak reverse voltage		
I _{F(RMS)} /pin	Forward rms current		7	Α
I _{F(AV)}	Average forward current $T_c = 150 ^{\circ}\text{C} \delta = 0.5$		10	Α
I _{FSM}	Surge non repetitive forward current $t_p = 10 \text{ ms sinusoidal}$		75	Α
I _{RRM}	Repetitive peak reverse current $t_p = 2 \mu s$, F= 1 kHz		1	Α
P _{ARM}	Repetitive peak avalanche power	4000	W	
T _{stg}	Storage temperature range	-65 to +175	°C	
Tj	Operating junction temperature range(-40 to +175	°C	
dV/dt	Critical rate of rise of reverse voltage	10000	V/µs	

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal parameters

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	3	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage	T _j = 25 °C	V - V	-	-	100	μΑ
'R`	current	T _j = 125 °C	$V_R = V_{RRM}$	-	7	15	mA
	V _F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I _F = 10 A	-	-	0.63	
V (2)		T _j = 125 °C		-	0.50	0.57	V
VF`		T _j = 25 °C	I _F = 20 A	-	-	0.84	V
		T _j = 125 °C	1F = 20 A	-	0.65	0.72	

^{1.} Pulse test: t_p = 5 ms, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 0.42 \times I_{F(AV)} + 0.015 I_{F}^{2}_{(RMS)}$$

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^{2.} Pulse test: t_p = 380 μ s, δ < 2%

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Figure 1. Average forward power dissipation Figure 2. Average forward current versus awbient temperature (δ = 0.5)

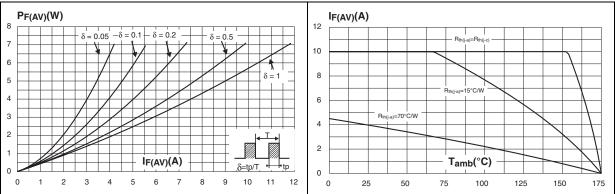


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

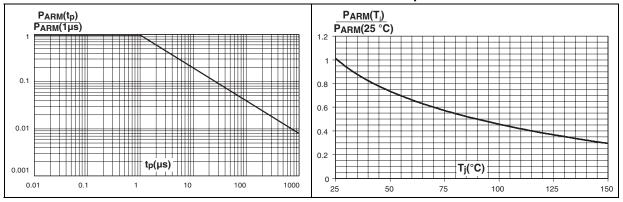
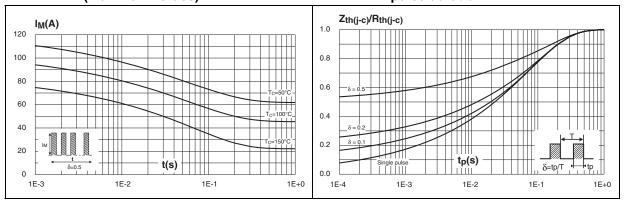


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

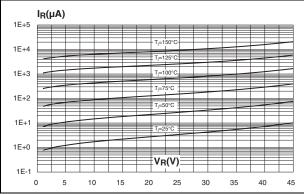
Figure 6. Relative variation of thermal impedance junction to case versus pulse duration



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Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

Figure 8. Junction capacitance versus reverse voltage applied (typical values)



C(pF)

1000

500

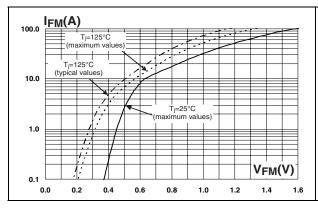
V_R(V)

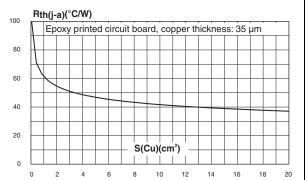
100

1 2 5 10 20 50

Figure 9. Forward voltage drop versus forward current

Figure 10. Thermal resistance junction to ambient versus copper surface under tab





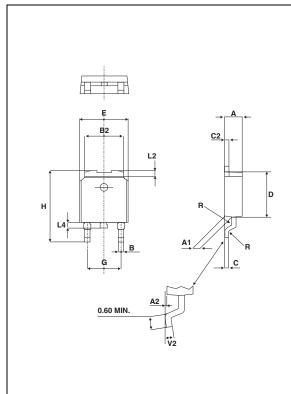
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2 Package information

- Epoxy meets UL94, V0
- Lead-free package

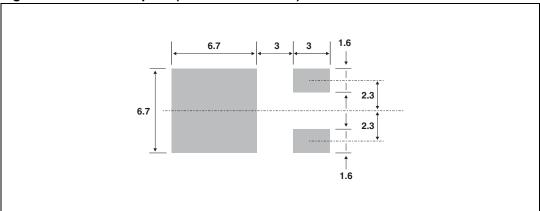
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Table 5. DPAK dimensions



		Dimensions				
Ref.	Millimeters Min. Max		Inc	hes		
			Min.	Max.		
Α	2.20	2.40	0.086	0.094		
A1	0.90	1.10	0.035	0.043		
A2	0.03	0.23	0.001	0.009		
В	0.64	0.90	0.025	0.035		
B2	5.20	5.40	0.204	0.212		
С	0.45	0.60	0.017	0.023		
C2	0.48	0.60	0.018	0.023		
D	6.00	6.20	0.236	0.244		
E	6.40	6.60	0.251	0.259		
G	4.40	4.60	0.173	0.181		
Н	9.35	10.10	0.368	0.397		
L2	0.80 typ.		0.03	1 typ.		
L4	0.60	1.00	0.023	0.039		
V2	0°	8°	0°	8°		

Figure 11. DPAK footprint (dimensions in mm)



Ordering information STPS1045B-Y

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS1045BY-TR	S1045Y	DPAK	0.30 g	2500	Tape and reel

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
23-May-2011	1	Initial release.

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